TI Power tech seminar for UIH

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TI's Power Businesses' Functions

Power Businesses

Advanced Low Power

Battery Management Solutions

DC Solutions

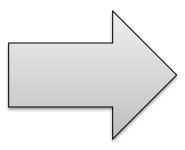
Linear Power

Power Supply

Power Stage

Power Products
Division

Mobile Power Devices



Power Functions

Battery Management

Display/Lighting

Linear Regulators

DC/DC Power

Isolated Power

RF Power

Protection & Sequencing

Load Switches

Gate Drivers

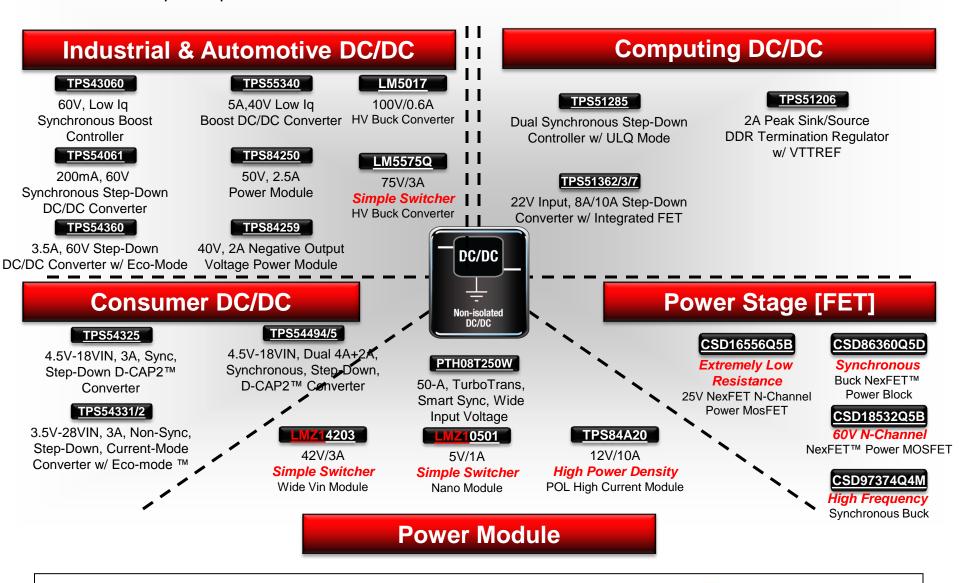


TEXAS

NSTRUMENTS

DC/DC Solutions at a glance...

#1 in power management market share with 19.4% 53 new DC/DC power products introduced in 2012



Battery Management at a glance...

#1 in power management market share with 19.4% 30 new battery management products introduced in 2012

http://power.ti.com

Single-Cell Chargers

BQ2404x

1A Charger, 30 V Input, w/ Support For USB, HV Chemistry (4.35V), Status Indicator Cost Competitive

BQ2425x

Industry's Smallest foot-print

2.0A Charger, USB2.0/3.0, BC1.2 I2C/Stand Alone, Power Path

BQ2426x Optimized Fast Charging

3.0A Charger, USB2.0/3.0, USB-OTG, Power Path, I2C, Dynamic

BQ2407x

1.5A Charger, 28V input, w/ Power Path

USB Support, Dynamic Pwr Mgmt

Low Cost/High Performance

Dynamic Pwr Mgmt **TPS**62736/BQ25570

Pwr Mgmt

Nano-power Buck/Boost Charger, 330nA Iq, MPPT, >90% efficient at low currents Extract uW to mW from ambient

Single-Cell Gauges/Monitoring

BQ27421

WCSP ROM based Low Cost Gauge

BQ27425-G2

WCSP ROM based

Low Cost Fuel Gauge

Fuel Gauge BQ27541-G1

BQ27530

WCSP Flash based

Charge Controller plus

QFN Flash based Pack Side Gauge

BQ27520-G4

WCSP Flash based **Programmable Fuel Gauge**

Multi-Cell Chargers

BQ24190x

Industry First 4.5A 1S charger Fully integrated w/ I2C Charge Fast, Stay Cool

BQ24195/5L

Industry First Single-Chip Power Bank

1S 2.5A/4.5A charger w/ I2C D+D- w/5.1BV 1A/2.1A OTG

BQ24133

High Integration 1-3S chargers Standalone and simple design 94% efficiency, 2.5A/4A charging

BQ2417x

High Integration 1-3S chargersStandalone and simple design

94% efficiency, 2.5A/4A charging

BQ246xx

1-6S chargers controller
Standalone for Li-ion, SuperCap, Solar
Cost competitive solution

Multi-Cell Gauges/Monitoring

BQ34Z950

Battery Management

> Impedence track + DQ + SMB gauge for high cell Li-Ion, Li-Polymer and Lead acid battery packs 1st DQ Soln w/ Impedance Track

BQ2945xy

Over voltage protectors for 2S-3S Li-Ion Batter Pack Small 2x2 QFN pkg

BQ76925

Analog Front End for 3S-6S Li-Ion battery
With internal cell balancing

BQ34Z1xx

Simple gas gauge for high cell Li-lon, Li-Polymer and Lead acid Battery packs

Impedance Track Fuel Gauge

BQ771z00

4S, 5S OVP Protector

BQ76PL536A

Stackable Analog Front End, Protection and Balancing for Automotive



Advanced Low Power at a glance...

#1 in power management market share with 19.4%

25 new battery management products introduced in 2012

http://power.ti.com

Display Power

TPS65150-Q1 4ch LCD bias

Flexible LCD supply for Automotive Integrated Vcom

Vs up to 15V (boost), <1% accuracy V_{GH} (with GVS) & V_{GI}

> **TPS65631** 2 output AMOLED

High efficiency and accuracy 300mA output

TPS65132 +/-5V SIMO

Highly flexible & **Programmable**

>86% efficiency 80mA output current CSP package

TPS61086 high A, 1ch boost High current boost up to 18.5V 2A switch

TPS65130 +/- 15V max Regulator

> Highly flexible and efficient

>85% efficiency 200mA output current

Integrated Display Lighting Solutions

TPS61162/3 2-Ch WLED Driver

2ch for 4-6" Smartphones

2.7V ~ 6.5V input voltage range Up to 38V output, 2x25mA one-wire dimming & analog dimming

> **TPS61176** 6ch WLED - tablets

6ch for Single-Cell Battery Supply Up to 38V output, 6 x 30mA Mixed-mode Dimming

TPS61196 6ch WLED driver - T\

6ch 200mA 1-D dimming

Up to 120V output voltage 200mA continuous / 400mA pulse independent PWM dimming

Low Power DC/DC Converters

TPS62130/40/50/60 Industrial

with 3 ext components

1A-4A 17V in buck

with DCS control

Industrial General purpose DC/DC reg. 3A Low Vin buck

TLV62090

High efficiency step down conv in 3x3 mm QFN pkg

TPS81256 Wireless

Integrated Pwr Soln

3W fully integrated, low nois& buck-boost in QFN/WCSP boost in MicroSiP pkg

TPS63020/25 Wireless

Highly Efficient

package

TPS623870 Processor Power

Remote Sensing

8A dual phase buck with DCS control

> TPS650380 Processor Power miniPMU

Triple multiphase buck, up to 6.8A

Advanced Portable Power

TPS65090

2-Ch WLED- smart phone

Highly integrated soln for single-cell Li-ion batt

Up to 90% efficacy 2.7V-6.5V input voltage

TPS65070 For batt. powered proc.

functions

5-ch Power mgmt IC with 3 Dc/DCs, 2 LDOs in 6x6mm QFN

TPS65912x PMU- Processor Powe

Highly integrated **PMUs**

> 4 bucks 10 LDOs 3 LED outputs

TPS650250 Pwr Mgt IC for Li-ion

One IC for all power Flexible and low cost PMU 3 DC/DC and 3 LDOs, Fully adjustable

TPS65050 6-ch Power Mgmt IC

Highly efficient

6-ch Power mamt IC with 2 DC/DCs, 4 LDOs, In 4x4 QFN

> **TPS65023** 6-ch Power Mgmt IC General purpose **PMIC**

3 DC/DCs, 3 LDOs, I2C interface and DVS



Linear Power at a glance...

#1 in power management market share with 19.4%

23 new battery management products introduced in 2012

LDOs and Supervisors

TLV713xx

150-mA Low-Dropout Regulator w/ Foldback Current Limit for Portable devices

TPS709xx

150-mA, 30V, Ultra-Low IQ, Wide Input Low-Dropout Regulator w/ Reverse Current Protection

TPS7A4700

Low Noise, 1A High Voltage Low-Dropout Regulator

Power Interface

TPS23753A

PoE Interface and Isolated Converter Controller w/ Enhanced ESD Ride-Through

TPS23751/2/3A/6

PoE PD with DC-DC Converter

TPS247x

3V-18V Converter Hot Swap

TPS25910

3V-20V Protection **eFuse**

LM(2)506x

Hot Swap/Monitoring
PMBus Monitoring

LM5050

High VoltageORing FET controller



WEBENCH® Design Center & PowerLab

www.ti.com/webench

ti.com/powerlab

WEBENCH® Design Tools Fast, Easy-To-Use Solutions

Power, lighting, sensors FPGA & processor power

TINA-TITM

Circuit Simulator

Thousands of models for offfline simulation

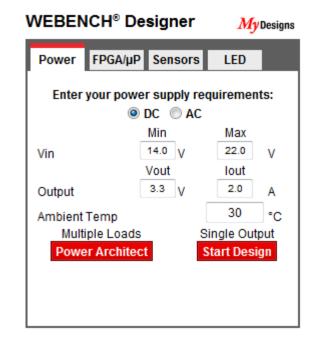
Downloadable Models

PSpice, IBIS, and more

PowerLab™

Reference Design Library

Hundreds of advanced power reference design examples



PowerLab™ Power Reference Designs Selection Tool

Reset All Criteria Hide Crite	eria	Launch Power Stage Desig	ner Contact the PowerLab team
Input voltage range Min (V) Output voltage + / - %	Output current + / - % Part (A) 0 •	Computers and Peripherals Consumer Electronics	Topology / Subtopology of devices associated Boost Buck Boost Buck
Isolated/non-isolated Isolated Non-isolated	Input type AC DC	Power for Processors LED Lighting, Driver and Display Processors Industrial	Flyback



SIMPLE SWITCHER® Regulators

A Legacy of Ease-of-Use





Gen 2: LM259x

Released: 1995
V_{IN} Increased to 60V and switching frequencies to 150 kHz, 3x higher than the previous generation



Gen 3: LM267x

Released: 1997 Switching frequency increased to 260 kHz and output accuracy improved. Leadless package and adjustable current limit first offered





2000



WEBENCH® Online Design Tools released for custom circuit designs in seconds



Gen 4: LM(2)557x

Released: 2007
Increase of Vin max up to 75V and introduction of emulated current mode



Gen 5: LM2267x/80

Released: 2008
Output current increased to 5A and switching frequencies up to 1 MHz



Gen 6: LM4360x/LM4600x

Released: 2014 Integrated synchronous FETs, high light-load efficiency architecture, switching frequencies up to 2.2 MHz







WEBENCH® FPGA Power Architect



Reference Design Library

WEBENCH® PCB Layout
and Schematic Export



Part Number Nomenclature

LM 4 VV II

4: Synchronous Simple Switcher feature set

- Fully synchronous
- Low quiescent current
- Power Good
- Precision Enable
- Internal compensation

Max Operating Input Rail

36: 36V Vin

60: 60V Vin

Output Current

00: 500mA

01: 1A

02: 2A

03: 3A

Example: LM43603

Synchronous family

• Max Vin: 36V

• lout: **3**A

LM557x Series

- Non-synchronous
- 6V to 75V input
- Up to 3A output
- TSSOP

LM2267x Series

- Non-synchronous
- 4.5V to 42V input
- Up to 5A output
- Internal comp
- PSOP, TO-263

LM4xxxx Series

- Synchronous
- 3.5V to 60V
- Up to 3A output
- Internal comp
- TSSOP
- Low I_o
- 200kHz to 2.2MHz Fsw



Gen6 36V -LM43600/1/2/3

0.5A/1A/2A/3A SIMPLE SWITCHER® Synchronous Buck Regulators

Features

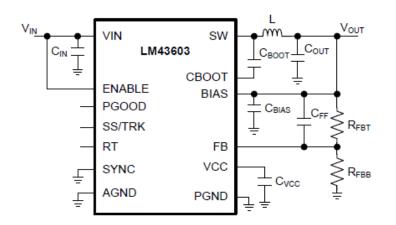
- Vin range 3.5V-36V
- Synchronous Peak Current Mode architecture
- Vout Range 1.0V to 28Vout
- Output current options: 0.5A/1A/2A/3A
- Internal Compensation
- Low 27µA operating quiescent current
- Precision Enable
- Default frequency of 500kHz, Adjustable or Synchronizable from 200kHz – 2.2MHz
- Internal or adjustable Soft-Start/Tracking
- Power Good output
- Operating Junction Temperature: -40 to 125C
- HTSSOP16 package

Applications

- Industrial
- Sub-AM band Automotive
- Networking
- Computing

Benefits

- · Wide Vin range to fit a variety of applications
- Improved efficiency compared to non-synchronous solutions
- Scalable footprint simplifies design reuse
- Minimized BOM count and solution size
- >80% efficiency at 1mA output current (12V→3.3V, 500kHz)
- Higher switching frequency allows smaller external filtering components
- Pin compatible with 60V 0.5A/1A/2A HTSSOP and 36V 0.5A/1A/2A HTSSOP





Gen6 60V - LM46000/01/2

0.5A/1A/2A SIMPLE SWITCHER® Synchronous Buck Regulators

Features

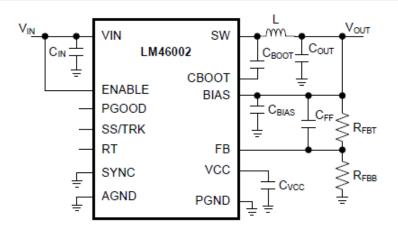
- Vin range 3.5V-60V
- Vout Range 1.0V to 28Vout
- Synchronous Peak Current Mode architecture
- Output current options: 0.5A/1A/2A
- Low 27µA operating quiescent current
- Precision Enable
- Default frequency of 500kHz, Adjustable or Synchronizable from 200kHz – 2.2MHz
- Internal or adjustable Soft-Start/Tracking
- Power Good output
- Internal Compensation
- Operating Junction Temperature: -40 to 125C
- HTSSOP16 package

Applications

- Industrial
- Sub AM-band 12V and 24V Automotive
- Networking
- Computing

Benefits

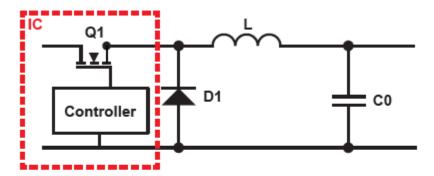
- Transient protection for 12V, 24V, 36V, 48V input systems
- Improved efficiency compared to non-synchronous solutions
- 75% efficiency at 1mA output current (12V→3.3V)
- Higher switching frequency allows smaller external filtering components
- Minimized BOM count and solution size
- Scalable footprint simplifies design reuse
- Pin compatible with 36V 0.5A/1A/2A/3A family



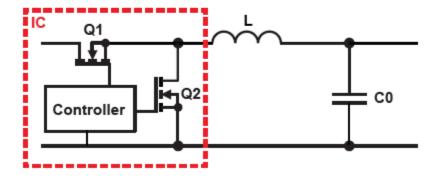


Advantages of a Synchronous Solution

Non-Synchronous



Synchronous



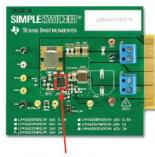
Smaller Solution Size

Typical Non-Synchronous EVM



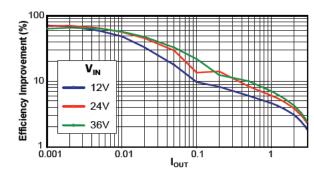
Total Regulator Area (IC + Diode) = 95 mm2

LM43603 Synchronous EVM

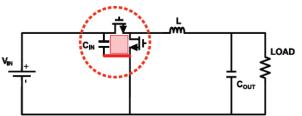


Total Regulator Area (IC) = 32 mm2

Improved Efficiency

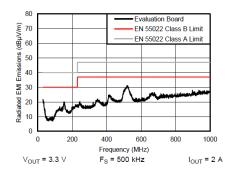


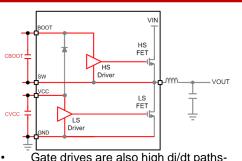
Better EMI Performance



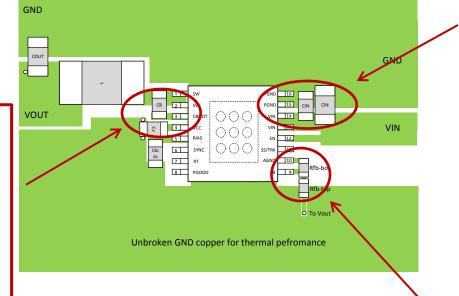


Pin-Out Optimized for EMI Performance

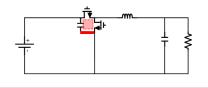


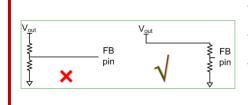


- Gate drives are also high di/dt paths-Keep C_{BOOT} and C_{VCC} bypass caps very close to the device pins to minimize loop area (inductance) in the high di/dt
- With LM4360x/LM4600x, the BOOT pin is located right next to SW – allows for close CBOOT placement with smallest possible loop area (lowest inductance) The VCC pin is next to BOOT



- The VIN and PGND location allows for the input cap to be placed as close as possible to the package.
- The SW pin is on the other side, so there is no need for the input cap to jump over the SW node.
- The loop area formed by the input cap, VIN, and PGND pins is minimized.

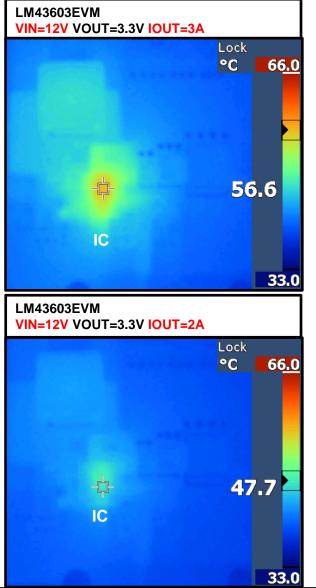


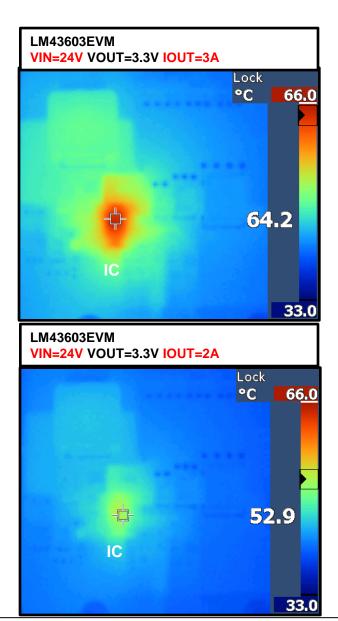


- Make long runs to low impedance nodes, short runs to high impedance nodes.
- Place output voltage divider close to the FB node (high impedance), farther from Vout (low impedance
- With LM4360x/LM4600x, the FB Pin is in the corner, shielded by AGND and away from noise sources. This makes it easy to place the divider right next to the FB pin, keeping this node as small as possible.



LM43603 EVM Ta=25°C



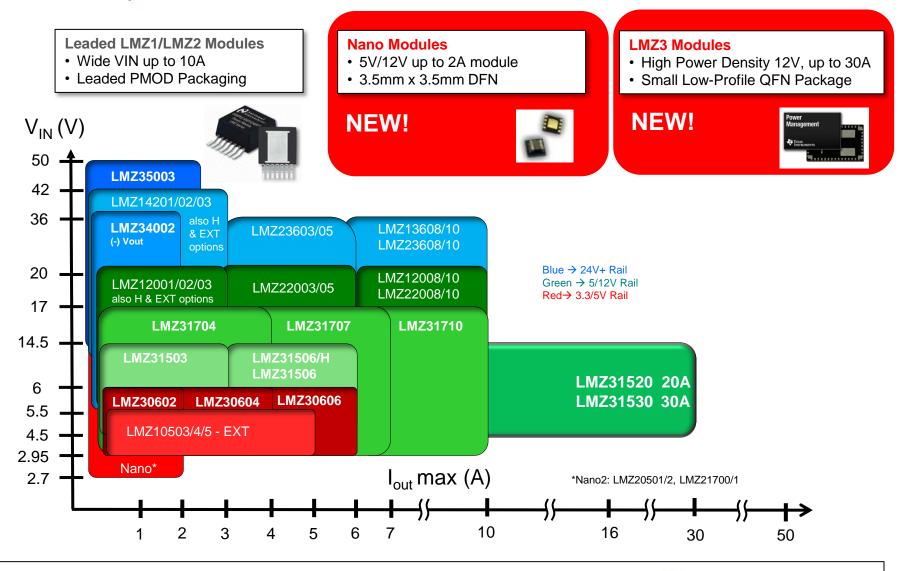




14

TI's SIMPLE SWITCHER® Power Module

Most Comprehensive Power Module Portfolio



TEXAS

INSTRUMENTS

Leaded & QFN Modules

LMZ A BB CC H EXT

Z: Power Modules

1: 1st Series

2: 2nd Series

3: 3rd Series

Example: LMZ23610

LMZ2-series

Max Vin: 36V

lout: 10A



LMZ1-Series

- Leaded
- Precision Enable
- Soft Start

Max Operating Input Rail

05: 5.5V Vin

20: 20V Vin

36: 36V Vin

42: 42 V Vin

01: 1A

Output

Current

02: 2A

10: 10A



EXT: Extended

Temp

H: High Output Voltage

LMZ2-Series

- Leaded
- Precision Enable
- Soft Start
- Frequency Sync
- Current Sharing

LMZ3-Series

- QFN
- Precision Enable
- Soft Start/Tracking
- Frequency Sync
- PGood
- Current Sharing*





Nano Modules

LMZ A BB CC

Z: Power Modules

1: 1st Series

2: 2nd Series

Max Operating

Input Rail **05**: 5.5V Vin

17: 17V Vin

Output Current

00: 500-650mA

01: 1A

02: 2A

Example: LMZ10501

LMZ1-series

Max Vin: 5.5V

• lout: 1A



LMZ1-Series

- Precision Enable
- Soft Start

LMZ2-Series

- Precision Enable
- Soft Start
- Ecomode
- PGOOD







Device Qualification

High Quality Devices

Individual Components & Final Product Qual tested

Happy to discuss any test in greater detail if interested

LMZ3 follow standard QFN soldering guidelines and are rated at MSL 3 as per JEDEC (parts don't need to be baked before soldering, providing the parts are used within 168 hours of the package being opened)

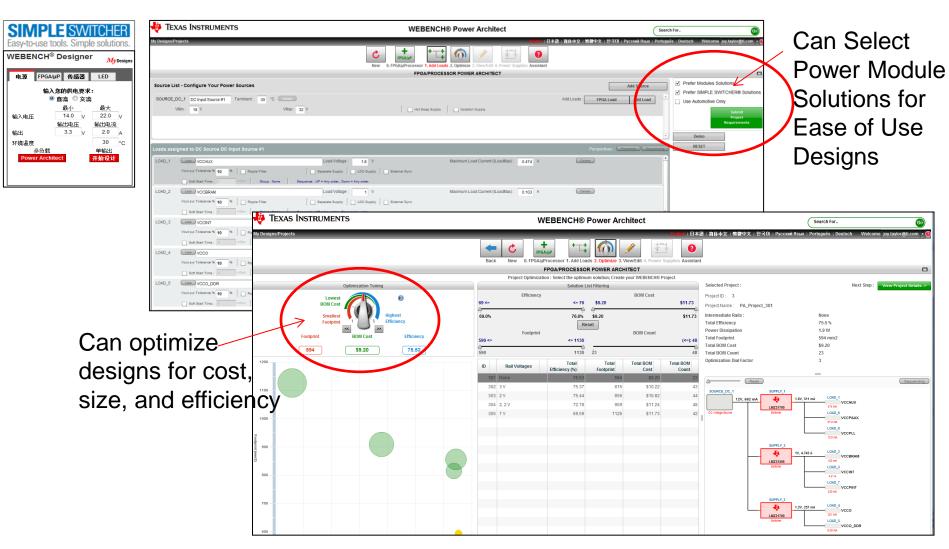
LMZ31506H Qualification Summary

LM25130011 Qualification Summary								
Test Type	Condition/Duration	Qty (Lots/Pieces)	Results					
Moisture Sensitivity	(Level 3 @ 260C peak +5/-0C)	27	Pass					
**Temp cycling -65C/150C	-65C/+150C (500, 1000* Cyc)	3/77	Pass					
**Unbiased HAST	110C/85%RH/17.7 psia (96, 264* hrs)	3/77	Pass					
**Biased Temp. Humidity	85C/85%RH (500, 1000 Hrs)	1/77	Pass					
BLR - Temp Cycle, -40/125C	-40/125C (1200) cycles)	1/42	Pass					
**High Temp. Storage Bake	150C (500 Hrs)	1/75	Pass					
**High Temp. Storage Bake	170C (168, 420hrs)	2/77	Pass					
**Steady-State Life Test	125C (500, 1000 Hrs)	2/77	Pass					
**Power Cycling	15 Minute Duty Cycle 1000 Hours	3/40	Pass					
Vibration	MIL-STD-883D, METHOD 2007.2 - Pass 20g	1/9	Pass					
Mechanical Shock	MIL-STD-883D, METHOD 2002.3 - pass 1500g	1/3	Pass					
Flammability	Method A - UL94-0	3/5	Pass					
Solderability	Steam age, 8 hours	3/22	Pass					
Salt Atmosphere	24Hours	3/22	Pass					
ESD HBM	+/-100V	1/3	Pass					
ESD MM	+/-100V	1/3	Pass					
ESD CDM	+/-500V	1/3	Pass					
Radiated Emissions	Pass - Class B EN55022 Regulations	1/3	Pass					
Conducted Emissions	Data Provided, Passed Class B EN55022	1/3	Pass					

^{** -} MSL 3 Preconditioning



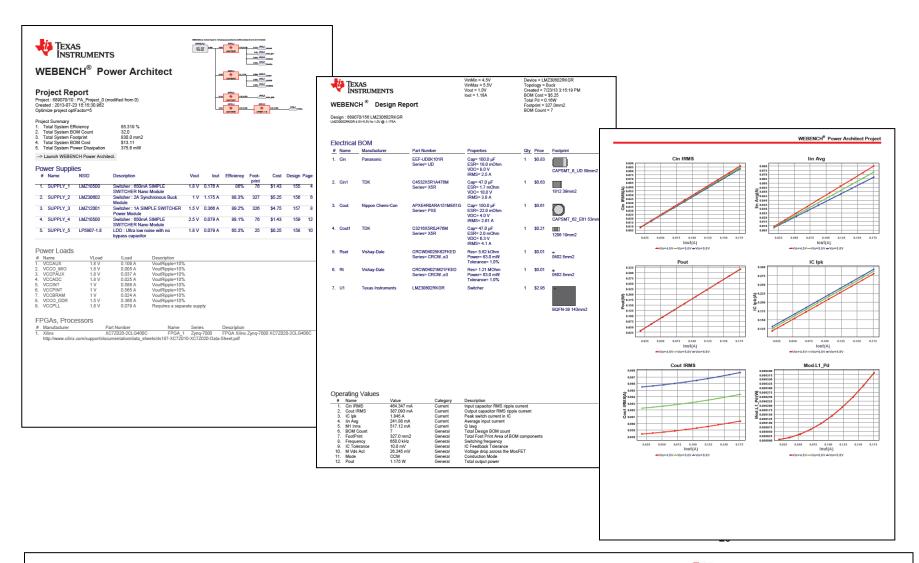
Tools: WEBENCH® FPGA Architect





Tools: FPGA Power Supply Design

Detail Report with Complete BOM, Electrical Performance

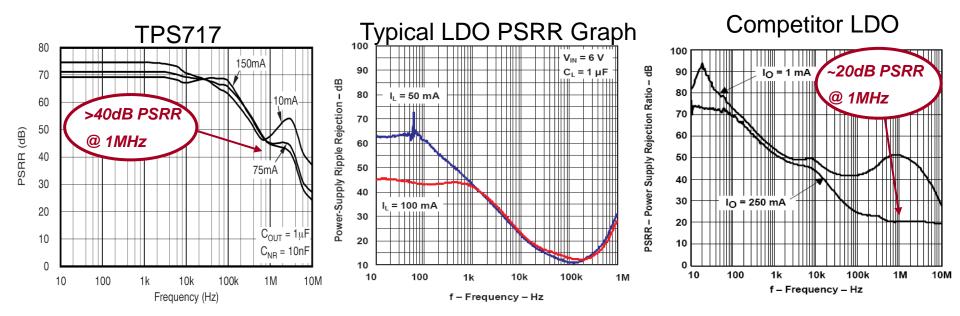






PSRR – Power Supply Rejection Ratio

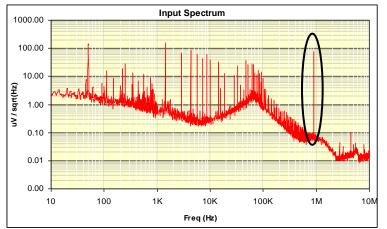
- Measurement of power supply's ability to reject/filter noise on the input bus
- Historically, LDOs have had poor high frequency PSRR performance
- Today, TI has LDOs with PSRR > 40dB @ 5MHz

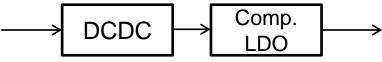


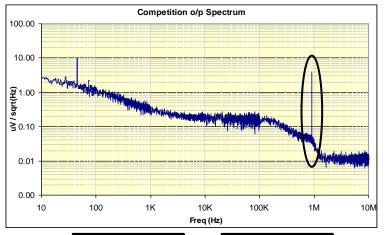
- Most LDOs have high PSRR at lower frequencies
- Having high PSRR over a large bandwidth is what distinguishes performance LDOs





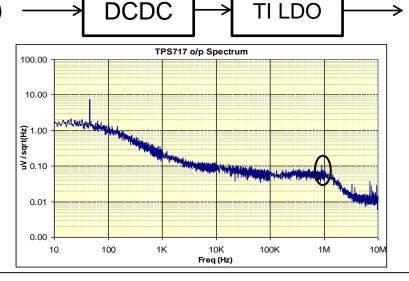






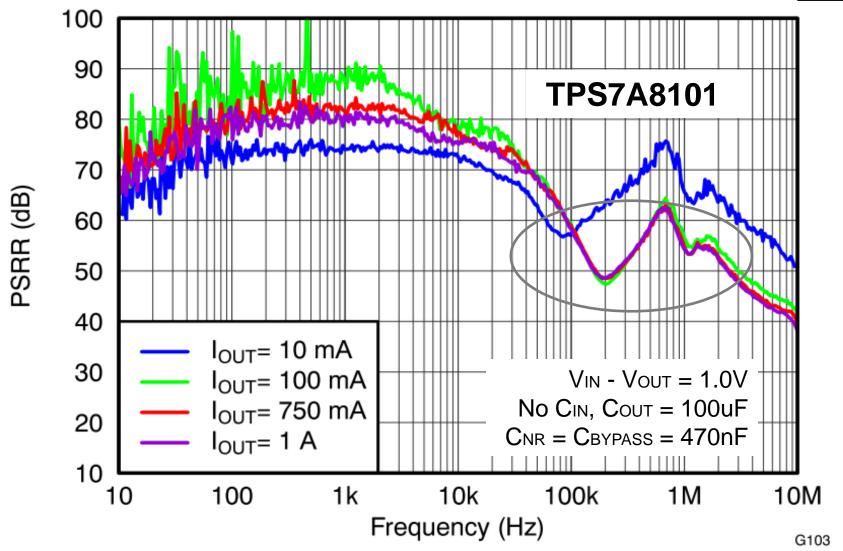
Switching frequency spike (~1MHz)

- Not attenuated by competition's LDO
- Attenuated by TPS717
- May show up at output of RF VCO which after mixing will affect the PA performance
- May fold back into audio band and create noise in audio application













Output Noise Density

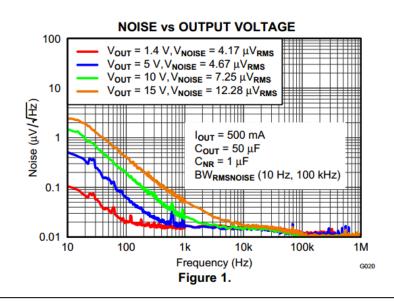
Random Noise due to statistical effects in conduction

- Split into two types:
 - Thermal and Bipolar Shot Noise
 - Flicker Noise

Having low output noise density ensures that the LDO is not affecting the rail

- You could just use opt for a *normal* LDO and try to filter its noise *BUT*:
 - A large filter is required to filter out low frequency noise
 - Your solution gets larger and more expensive

TPS7A4700 Noise Spectrum Density





Quiet Supply LDO Solutions



TPS7A4700/1 (4μV_{RMS})

Vin: 3-36V lout: 1A **TPS7A8300**

(6μV_{RMS}) Vin: 1.1-6.5V lout: 2A TPS7A3301

(16µV_{RMS}) Vin: -3 to -36V lout: 1A TPS7A8101

(18µV_{RMS}) Vin: 2.2-6.5V Iout:1A

(5µV_{RMS})

lout

Vin: 3V-20V

LP38798

TPS7A3501

(3.8µV_{RMS}) Vin: 1.7V – 5.0V lout: 1A LP3878

(18µV_{RMS}) Vin: 2.5V-16V lout: 800mA

LP8900

(6μV_{RMS}) Vin: 1.8V–5.5V

√in: 1.8V–5.5\ Iout: 200mA TPS7A3001

(14µV_{RMS}) Vin: -3 to -36V

/iii. -3 to -36v Iout: 200mA LP2989

 $(18\mu V_{RMS})$

Vin: 2.8V–16V lout: 500mA

LP5900/07

(6µV_{RMS})

Vin: 2.2V-5.5V lout: 150mA/250mA TPS7A4901

(12µV_{RMS}) Vin: 3-36V Iout: 150mA LP3995 (25µV_{RMS})

Vin: 2.5V-6V lout: 150mA

Output Noise

Quiet Supply LDO Solutions Table



_	TPS7A83	TPS7A47	TPS7A33	LP38798	LP2989	LP5900/7	LP8900	TPS7A30	TPS7A49	TPS7A35
lout (A)	2	1	1	0.8	0.5	0.15/0.25	0.2	0.2	0.15	1
Vin (V)	1.1-6.5	3-36	-3 to -36	3-20	2.8-16	2.5-5.5	1.8-5.5	-3 to -36	3-36	1.4 - 5
V оит (V)	0.8-5	1.4-34	-1.18 to -33	1.2-11.8	2.5-5	1.5-3.3 (fixed)	1.2-3.6 (fixed)	-1.18 to -33	1.2-33	1.2 – 4.5
Vout Accuracy (%)	+/-1	+/-1	+/-1	+/-1	+/-0.75	+/-2	+/-1	+/-1.5	+/-1.5	+/- 30mV
Dropout (mV)	125 @ 2A	307 @ 1A	307 @	200 @ 800mA	310 @ 500 mA	80/120 @ 150/200mA	110 @ 200mA	215 @ 100mA	260 @ 100mA	200 – 500
Output Noise	6uVrms	4uVrms	16uVrms	5uVrms	18uVrms	6.5/10 uVrms	6uVrms	14uVrms	12.7uVrms	3.8uVrms
PSRR @ 100kHz (dB)	43	60	64	60	60	60	45	55	53	40
Package (bold: smallest)	20-SON	20-SON	20-SON 7-TO-220	12-SON	8SOIC 8VSSOP 8WSON	4-DSBGA 6-SON 4-SON 5SOT-23	6-DSBGA	8MSOP- PowerPAD	8MSOP- PowerPAD	6-SON
Solution size	5x5mm + 4 caps + 1 resistor	5x5mm + 3 caps	5x5mm + 3 caps	4x4mm + 3 caps + 2 resistors	3x3.8m + 3 caps + 1 resistor	0.65x0.65m + 2 caps	1.5x1.1mm + 3 caps	3x5mm + 4 caps + 2 resistors	3x5mm + 4 caps + 2 resistors	2x2mm + 3 caps + 1 resistor



Thank You



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